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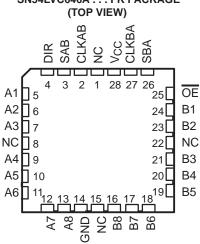
- EPIC[™] (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} = 3.3 V, $T_A = 25^{\circ}C$
- Typical V_{OHV} (Output V_{OH} Undershoot)
 > 2 V at V_{CC} = 3.3 V, T_A = 25°C
- Power Off Disables Outputs, Permitting Live Insertion
- Support Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- ESD Protection Exceeds 2000 V Per MIL-STD-833, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW) Packages, and Ceramic Chip Carriers (FK)

description

The SN54LVC646A octal bus transceiver and register is designed for 2.7-V to 3.6-V V_{CC} operation and the SN74LVC646A octal bus transceiver and register is designed for 1.65-V to 3.6-V V_{CC} operation.

These devices consist of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that are performed with the 'LVC646A.

SN74LVC646A	. DB, D (TOP VI		PW PACKAGE
CLKAB [SAB [DIR [A1 [A2 [A3 [A4 [A5 [A7 [A8 [GND [6 7	24 23 22 21 20 19 18 17 16 15 14 13	V _{CC} CLKBA SBA OE B1 B2 B3 B4 B5 B6 B7 B8
SN54LVC6 일 명	(TOP VI ସ ∀		ACKAGE



NC - No internal connection

Output-enable (\overline{OE}) and direction-control (DIR) inputs control the transceiver functions. In the transceiver mode, data present at the high-impedance port is stored in either register or in both.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. DIR determines which bus receives data when \overline{OE} is low. In the isolation mode (\overline{OE} high), A data is stored in one register and B data can be stored in the other register.

When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.



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description (continued)

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54LVC646A is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74LVC646A is characterized for operation from -40° C to 85° C.

		INP	UTS			DAT	A I/O	OPERATION OR FUNCTION						
OE	DIR	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	OPERATION OR FUNCTION						
Х	Х	\uparrow	Х	Х	Х	Input	Unspecified [†]	Store A, B unspecified [†]						
Х	Х	Х	\uparrow	Х	Х	Unspecified [†]	Input	Store B, A unspecified [†]						
Н	Х	\uparrow	\uparrow	Х	Х	Input	Input	Store A and B data						
н	Х	H or L	H or L	Х	Х	Input disabled	Input disabled	Isolation, hold storage						
L	L	Х	Х	Х	L	Output	Input	Real-time B data to A bus						
L	L	Х	H or L	Х	Н	Output	Input	Stored B data to A bus						
L	Н	Х	Х	L	Х	Input	Output	Real-time A data to B bus						
L	Н	H or L	Х	Н	Х	Input	Output	Stored A data to B bus						

FUNCTION TABLE

[†] The data-output functions can be enabled or disabled by various signals at \overline{OE} and DIR. Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.





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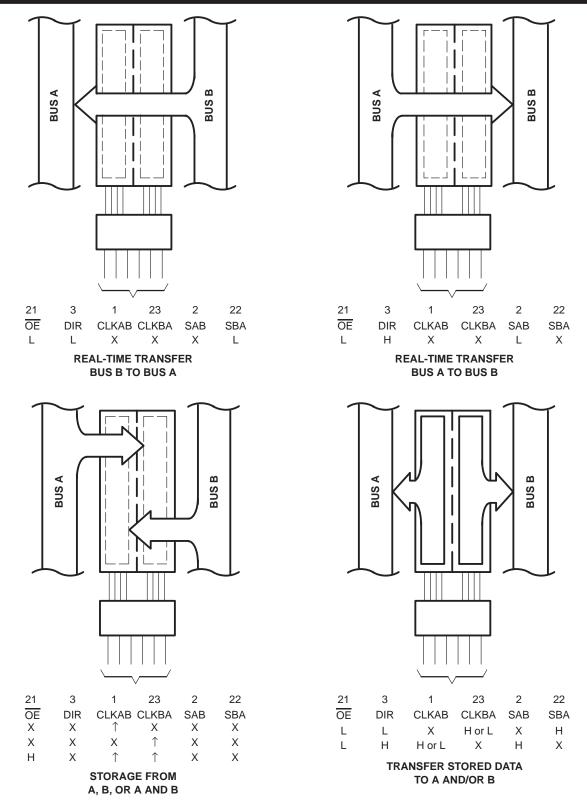
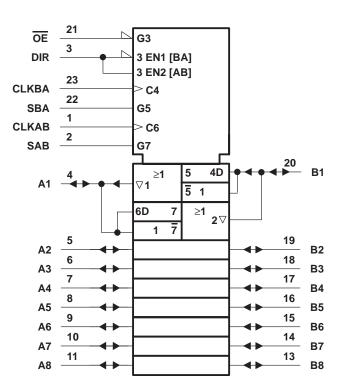


Figure 1. Bus-Management Functions

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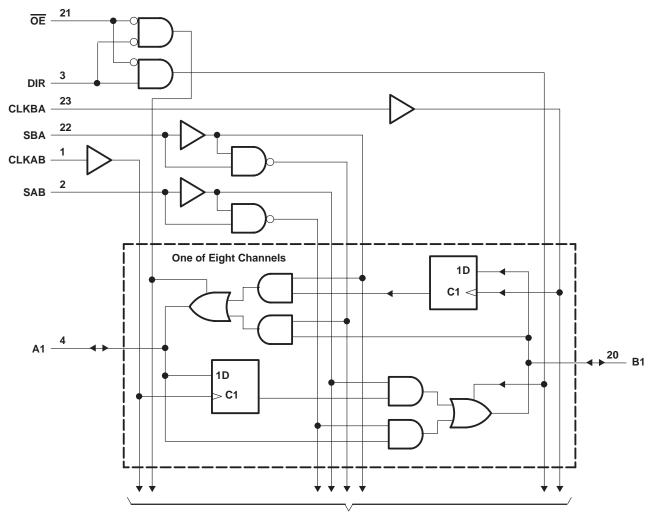
logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DB, DW, and PW packages.



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To Seven Other Channels

Pin numbers shown are for the DB, DW, and PW packages.

logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input voltage range, V_{I} : (see Note 1) Voltage range applied to any output in the high-impedance or power-off state, V_{O}	$\ldots \ldots \ldots -0.5$ V to 6.5 V
(see Note 1)	–0.5 V to 6.5 V
Voltage range applied to any output in the high or low state, V _O	
(see Notes 1 and 2)	\ldots –0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	–50 mA
Output clamp current, I _{OK} (V _O < 0)	
Continuous output current, I _O	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DB package	104°C/W
DW package	81°C/W
PW package	120°C/W
Storage temperature range, T _{stg}	–65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. The value of V_{CC} is provided in the recommended operating conditions table.
- 3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

			SN54L	VC646A	SN74L	/C646A	UNIT	
			MIN	MAX	MIN	MAX	UNIT	
Vaa	Supply voltogo	Operating	2	3.6	1.65	3.6	v	
VCC	Supply voltage	Data retention only	1.5		1.5		v	
		V _{CC} = 1.65 V to 1.95 V			0.65×VCC			
VIH	High-level input voltage	V_{CC} = 2.3 V to 2.7 V			1.7		V	
		V _{CC} = 2.7 V to 3.6 V	2		2			
		V _{CC} = 1.65 V to 1.95 V				0.35×VCC		
VIL	Low-level input voltage	V _{CC} = 2.3 V to 2.7 V				0.7	V	
		V _{CC} = 2.7 V to 3.6 V		0.8		0.8		
VI	Input voltage		0	5.5	0	5.5	V	
\/_	Output voltage	High or low state	0	VCC	0	VCC	V	
VO		3 state	0	5.5	0	5.5	v	
		V _{CC} = 1.65 V				-4		
1	Lich lovel output ourrest	V _{CC} = 2.3 V				-8		
ЮН	High-level output current	V _{CC} = 2.7 V		-12		-12	mA	
		$V_{CC} = 3 V$		-24		-24		
		V _{CC} = 1.65 V				4		
1		V _{CC} = 2.3 V				8		
IOL	Low-level output current	V _{CC} = 2.7 V		12		12	mA	
		V _{CC} = 3 V		24		24		
$\Delta t/\Delta v$	Input transition rise or fall rate		0	10	0	10	ns/V	
Тд	Operating free-air temperature		-55	125	-40	85	°C	

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DA	DAMETER	TEST CONDITIONS		SN54	LVC646	4	SN74	LVC646	Α	UNIT		
PARAMETER		TEST CONDITIONS	Vcc	MIN	TYP†	MAX	MIN	TYP†	MAX			
		100.04	1.65 V to 3.6 V				V _{CC} -0.2					
		I _{OH} = -100 μA	2.7 V to 3.6 V	V _{CC} -0.2								
		$I_{OH} = -4 \text{ mA}$	1.65 V				1.2					
VOH		I _{OH} = –8 mA	2.3 V				1.7			V		
VOn		I _{OH} = -12 mA	2.7 V	2.2			2.2					
		IOH = -12 IIIA	3 V	2.4			2.4					
		I _{OH} = -24 mA	3 V	2.2			2.2					
		I _{OL} = 100 μA						0.2				
		$IOL = 100 \mu \text{A}$	2.7 V to 3.6 V			0.2						
M	I _{OL} = 4 mA	1.65 V						0.45	V			
VOL		I _{OL} = 8 mA	2.3 V						0.7	ľ		
		I _{OL} = 12 mA	2.7 V			0.4			0.4			
		I _{OL} = 24 mA	3 V			0.55			0.55			
Ι	Control inputs	V _I = 0 to 5.5 V	3.6 V			±5			±5	μΑ		
loff		$V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	0						±10	μΑ		
loz‡		V _O = 0 to 5.5 V	3.6 V			±15			±10	μΑ		
		$V_{I} = V_{CC} \text{ or } GND$	0.01/			10			10			
ICC		$3.6 V \le V_{\rm I} \le 5.5 V_{\rm S}$ $I_{\rm O} = 0$	3.6 V			10			10	μA		
∆ICC		One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND	2.7 V to 3.6 V			500			500	μA		
Ci	Control inputs	$V_I = V_{CC}$ or GND	3.3 V		4.5			4.5		pF		
Cio	A or B ports	$V_{O} = V_{CC}$ or GND	3.3 V		7.5			7.5		pF		

[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. [‡] For I/O ports, the parameter I_{OZ} includes the input leakage current.

§ This applies in the disabled state only.

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 4)

			SN54LV	/C646A		
		V _{CC} = 2.7 V V _{CC} = 3.3 V ± 0.3 V MIN MAX		UNIT		
		MIN	MAX	MIN	MAX	
fclock	Clock frequency		150		150	MHz
tw	Pulse duration	3.3		3.3		ns
t _{su}	Setup time, data before CLK [↑]	1.6		1.5		ns
th	Hold time, data after CLK [↑]	1.7		1.7		ns



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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figures 2 through 4)

	SN74LVC646A									
		V _{CC} = ± 0.1	1.8 V 5 V	= ۷ _{CC} ± 0.		V _{CC} =	2.7 V	= ۷ _{CC} ± 0.3	3.3 V 3 V	UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency		†		†		150		150	MHz
tw	Pulse duration	†		†		3.3		3.3		ns
t _{su}	Setup time, data before CLK [↑]	†		†		1.6		1.5		ns
t _h	Hold time, data after CLK^\uparrow	†		†		1.7		1.7		ns

[†] This information was not available at the time of publication.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} =	2.7 V	= V _{CC} ± 0.3	UNIT	
			MIN	MAX	MIN	MAX	
f _{max}			150		150		MHz
	A or B	B or A		7.9	1	7.4	
^t pd	CLK	A or B		8.8	1	8.4	ns
	SBA or SAB	AOIB		9.9	1	8.6	
t _{en}	OE	A		10.2	1	8.2	ns
^t dis	OE	А		8.9	1	7.5	ns
t _{en}	DIR	В		10.4	1	8.3	ns
^t dis	DIR	В		8.7	1	7.9	ns

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 2 through 4)

			SN74LVC646A								
PARAMETER	FROM (INPUT)	TO (OUTPUT)		V _{CC} = 1.8 V ± 0.15 V		V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V	
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
fmax			†		†		150		150		MHz
	A or B	B or A	†	†	†	†		7.9	1.4	7.4	
^t pd	CLK		†	†	†	†		8.8	1.3	8.4	ns
	SBA or SAB	AOIB	†	†	†	†		9.9	1.4	8.6	
t _{en}	OE	A	†	†	†	†		10.2	1	8.2	ns
^t dis	OE	A	†	†	†	†		8.9	1	7.5	ns
t _{en}	DIR	В	†	†	†	†		10.4	1.2	8.3	ns
^t dis	DIR	В	†	†	†	†		8.7	1.1	7.9	ns

[†] This information was not available at the time of publication.



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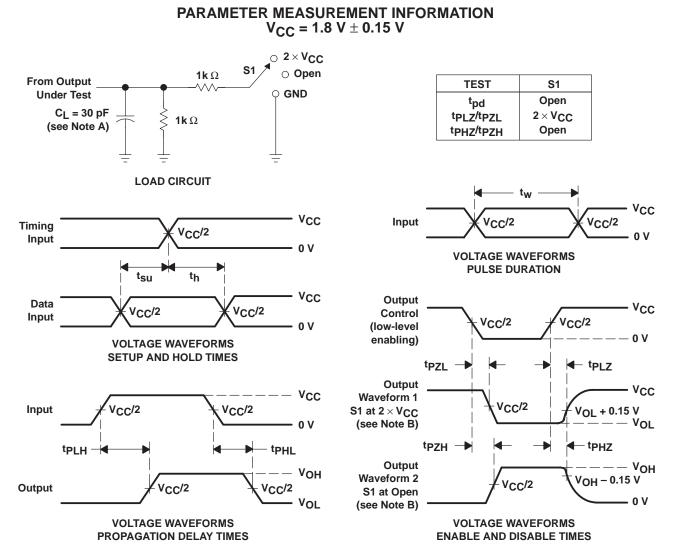
operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	V _{CC} = 1.8 V ± 0.15 V	V _{CC} = 2.5 V ± 0.2 V	V _{CC} = 3.3 V ± 0.3 V	UNIT		
			CONDITIONS	TYP	TYP	P TYP		
Cpd	Power dissipation capacitance	Outputs enabled	f = 10 MHz	†	†	75	ъE	
Cpa	per transceiver	Outputs disabled		†	†	9	рF	

[†] This information was not available at the time of publication.



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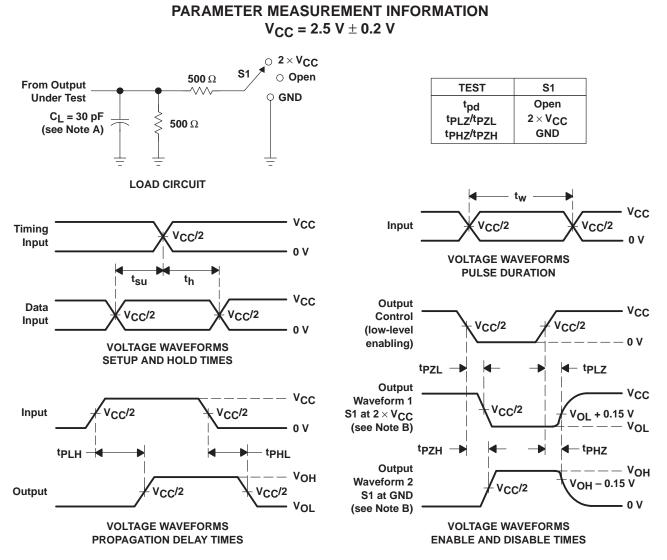


- NOTES: A. CL includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR≤10 MHz, Z_O = 50 Ω, t_f≤2 ns, t_f≤2 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. tp_{I 7} and tp_{H7} are the same as t_{dis} .
 - F. tpzL and tpzH are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .





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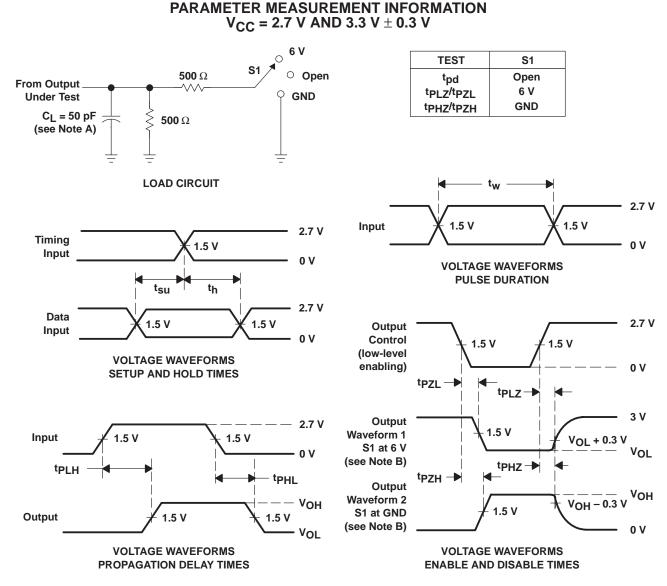
- NOTES: A. CI includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2 ns, t_f \leq 2 ns.
 - D. The outputs are measured one at a time with one transition per measurement.

 - E. tPLZ and tPHZ are the same as tdis. F. tpzL and tpzH are the same as ten.
 - G. tpl H and tpHI are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms



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 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PI7} and t_{PH7} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 4. Load Circuit and Voltage Waveforms



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